

Electronic Patent Application Fee Transmittal

Application Number:	09590795			
Filing Date:	08-Jun-2000			
Title of Invention:	METHODS FOR FORMING AND INTEGRATED CIRCUIT STRUCTURES CONTAINING RUTHENIUM AND TUNGSTEN CONTAINING LAYERS			
First Named Inventor:	Vishnu K. Agarwal			
Filer:	J. Mike Amerson/Mary Paul			
Attorney Docket Number:	6047-53173			
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Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Filing a brief in support of an appeal	1402	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
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